

## FEATURES

- **Smallest Pin-Compatible Octal DACs:**  
**LTC2605: 16 Bits**  
**LTC2615: 14 Bits**  
**LTC2625: 12 Bits**
- **Guaranteed Monotonic Over Temperature**
- 400kHz I<sup>2</sup>C Interface
- Wide 2.7V to 5.5V Supply Range
- Low Power Operation: 250μA per DAC at 3V
- Individual Channel Power-Down to 1μA (Max)
- Ultralow Crosstalk Between DACs (<10μV)
- High Rail-to-Rail Output Drive (±15mA, Min)
- Double-Buffered Digital Inputs
- 27 Selectable Addresses
- LTC2605/LTC2615/LTC2625: Power-On Reset to Zero-Scale
- LTC2605-1/LTC2615-1/LTC2625-1: Power-On Reset to Mid-Scale
- Tiny 16-Lead Narrow SSOP Package

## APPLICATIONS

- Mobile Communications
- Process Control and Industrial Automation
- Instrumentation
- Automatic Test Equipment

## DESCRIPTION

The LTC®2605/LTC2615/LTC2625 are octal 16-, 14- and 12-bit, 2.7V to 5.5V rail-to-rail voltage-output DACs in 16-lead narrow SSOP packages. They have built-in high performance output buffers and are guaranteed monotonic.

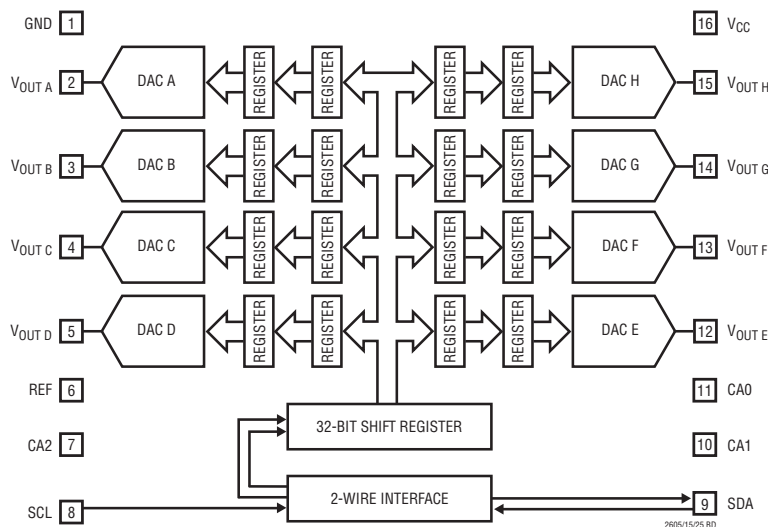
These parts establish new board-density benchmarks for 16-/14-bit DACs and advance performance standards for output drive, crosstalk and load regulation in single supply, voltage-output multiples.

The parts use the 2-wire I<sup>2</sup>C compatible serial interface. The LTC2605/LTC2615/LTC2625 operate in both the standard mode (maximum clock rate of 100kHz) and the fast mode (maximum clock rate of 400kHz).

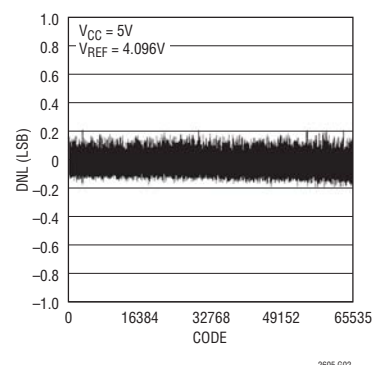
The LTC2605/LTC2615/LTC2625 incorporate a power-on reset circuit. During power-up, the voltage outputs rise less than 10mV above zero-scale; and after power-up, they stay at zero-scale until a valid write and update take place. The power-on reset circuit resets the LTC2605-1/LTC2615-1/LTC2625-1 to mid-scale. The voltage output stays at mid-scale until a valid write and update takes place.

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## TYPICAL APPLICATION



Differential Nonlinearity (LTC2605)



# LTC2605/LTC2615/LTC2625

## ABSOLUTE MAXIMUM RATINGS

(Note 1)

Any Pin to GND ..... -0.3V to 6V

Any Pin to  $V_{CC}$  ..... -6V to 0.3V

Maximum Junction Temperature ..... 125°C

Operating Temperature Range

LTC2605C/LTC2615C/LTC2625C ..... 0°C to 70°C

LTC2605C-1/LTC2615C-1/LTC2625C-1 .... 0°C to 70°C

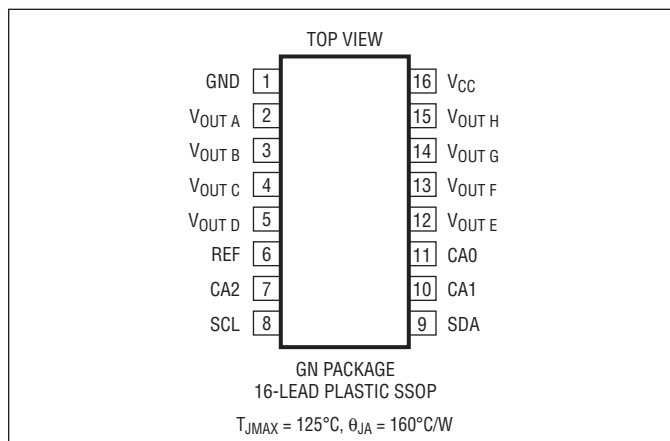
LTC2605I/LTC2615I/LTC2625I ..... -40°C to 85°C

LTC2605I-1/LTC2615I-1/LTC2625I-1 .... -40°C to 85°C

Storage Temperature Range ..... -65°C to 150°C

Lead Temperature (Soldering, 10 sec)..... 300°C

## PIN CONFIGURATION



## ORDER INFORMATION

| LEAD FREE FINISH | TAPE AND REEL      | PART MARKING | PACKAGE DESCRIPTION  | TEMPERATURE RANGE |
|------------------|--------------------|--------------|----------------------|-------------------|
| LTC2605CGN#PBF   | LTC2605CGN#TRPBF   | 2605         | 16-Lead Plastic SSOP | 0°C to 70°C       |
| LTC2605CGN-1#PBF | LTC2605CGN-1#TRPBF | 26051        | 16-Lead Plastic SSOP | 0°C to 70°C       |
| LTC2605IGN#PBF   | LTC2605IGN#TRPBF   | 2605I        | 16-Lead Plastic SSOP | -40°C to 85°C     |
| LTC2605IGN-1#PBF | LTC2605IGN-1#TRPBF | 2605I1       | 16-Lead Plastic SSOP | -40°C to 85°C     |
| LTC2615CGN#PBF   | LTC2615CGN#TRPBF   | 2615         | 16-Lead Plastic SSOP | 0°C to 70°C       |
| LTC2615CGN-1#PBF | LTC2615CGN-1#TRPBF | 26151        | 16-Lead Plastic SSOP | 0°C to 70°C       |
| LTC2615IGN#PBF   | LTC2615IGN#TRPBF   | 2615I        | 16-Lead Plastic SSOP | -40°C to 85°C     |
| LTC2615IGN-1#PBF | LTC2615IGN-1#TRPBF | 2615I1       | 16-Lead Plastic SSOP | -40°C to 85°C     |
| LTC2625CGN#PBF   | LTC2625CGN#TRPBF   | 2625         | 16-Lead Plastic SSOP | 0°C to 70°C       |
| LTC2625CGN-1#PBF | LTC2625CGN-1#TRPBF | 26251        | 16-Lead Plastic SSOP | 0°C to 70°C       |
| LTC2625IGN#PBF   | LTC2625IGN#TRPBF   | 2625I        | 16-Lead Plastic SSOP | -40°C to 85°C     |
| LTC2625IGN-1#PBF | LTC2625IGN-1#TRPBF | 2625I1       | 16-Lead Plastic SSOP | -40°C to 85°C     |

Consult LTC Marketing for parts specified with wider operating temperature ranges.

Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandreel/>

**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $\text{REF} = 4.096\text{V}$  ( $V_{CC} = 5\text{V}$ ),  $\text{REF} = 2.048\text{V}$  ( $V_{CC} = 2.7\text{V}$ ),  $V_{OUT}$  unloaded, unless otherwise noted.

| SYMBOL          | PARAMETER                               | CONDITIONS                                           |   | LTC2625/LTC2625-1 |       |      | LTC2615/LTC2615-1 |     |     | LTC2605/LTC2605-1 |     |     | UNITS  |
|-----------------|-----------------------------------------|------------------------------------------------------|---|-------------------|-------|------|-------------------|-----|-----|-------------------|-----|-----|--------|
|                 |                                         |                                                      |   | MIN               | TYP   | MAX  | MIN               | TYP | MAX | MIN               | TYP | MAX |        |
| DC Performance  |                                         |                                                      |   |                   |       |      |                   |     |     |                   |     |     |        |
|                 | Resolution                              |                                                      | ● | 12                |       |      | 14                |     |     | 16                |     |     | Bits   |
|                 | Monotonicity                            | (Note 2)                                             | ● | 12                |       |      | 14                |     |     | 16                |     |     | Bits   |
| DNL             | Differential Nonlinearity               | (Note 2)                                             | ● | ±0.5              |       |      | ±1                |     |     | ±1                |     |     | LSB    |
| INL             | Integral Nonlinearity                   | (Note 2)                                             | ● | ±1 ±4             |       |      | ±4 ±16            |     |     | ±18 ±64           |     |     | LSB    |
|                 | Load Regulation                         | V <sub>REF</sub> = V <sub>CC</sub> = 5V, Mid-Scale   |   |                   |       |      |                   |     |     |                   |     |     |        |
|                 |                                         | I <sub>OUT</sub> = 0mA to 15mA Sourcing              | ● | 0.02              | 0.125 | 0.07 | 0.5               | 0.3 | 2   | LSB/mA            |     |     |        |
|                 |                                         | I <sub>OUT</sub> = 0mA to 15mA Sinking               | ● | 0.03              | 0.125 | 0.10 | 0.5               | 0.4 | 2   | LSB/mA            |     |     |        |
|                 |                                         | V <sub>REF</sub> = V <sub>CC</sub> = 2.7V, Mid-Scale |   |                   |       |      |                   |     |     |                   |     |     |        |
|                 |                                         | I <sub>OUT</sub> = 0mA to 7.5mA Sourcing             | ● | 0.04              | 0.25  | 0.15 | 1                 | 0.6 | 4   | LSB/mA            |     |     |        |
|                 |                                         | I <sub>OUT</sub> = 0mA to 7.5mA Sinking              | ● | 0.07              | 0.25  | 0.20 | 1                 | 0.8 | 4   | LSB/mA            |     |     |        |
| ZSE             | Zero-Scale Error                        | Code = 0                                             | ● | 1.7 9             |       |      | 1.7 9             |     |     | 1.7 9             |     |     | mV     |
| V <sub>OS</sub> | Offset Error                            | (Note 4)                                             | ● | ±1 ±9             |       |      | ±1 ±9             |     |     | ±1 ±9             |     |     | mV     |
|                 | V <sub>OS</sub> Temperature Coefficient |                                                      |   | ±5                |       |      | ±5                |     |     | ±5                |     |     | µV/°C  |
| GE              | Gain Error                              |                                                      | ● | ±0.1 ±0.7         |       |      | ±0.1 ±0.7         |     |     | ±0.1 ±0.7         |     |     | %FSR   |
|                 | Gain Temperature Coefficient            |                                                      |   | ±8                |       |      | ±8                |     |     | ±8                |     |     | ppm/°C |

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $\text{REF} = 4.096\text{V}$  ( $V_{CC} = 5\text{V}$ ),  $\text{REF} = 2.048\text{V}$  ( $V_{CC} = 2.7\text{V}$ ),  $V_{OUT}$  unloaded, unless otherwise noted. (Note 9)

| SYMBOL    | PARAMETER                    | CONDITIONS                                                                                   |   | MIN | TYP       | MAX  | UNITS                   |
|-----------|------------------------------|----------------------------------------------------------------------------------------------|---|-----|-----------|------|-------------------------|
| PSR       | Power Supply Rejection       | $V_{CC} \pm 10\%$                                                                            |   |     | -80       |      | dB                      |
| $R_{OUT}$ | DC Output Impedance          | $V_{REF} = V_{CC} = 5\text{V}$ , Mid-Scale; $-15\text{mA} \leq I_{OUT} \leq 15\text{mA}$     | ● |     | 0.02      | 0.15 | $\Omega$                |
|           |                              | $V_{REF} = V_{CC} = 2.7\text{V}$ , Mid-Scale; $-7.5\text{mA} \leq I_{OUT} \leq 7.5\text{mA}$ | ● |     | 0.03      | 0.15 | $\Omega$                |
|           | DC Crosstalk (Note 10)       | Due to Full-Scale Output Change (Note 11)                                                    |   |     | $\pm 10$  |      | $\mu\text{V}$           |
|           |                              | Due to Load Current Change                                                                   |   |     | $\pm 3.5$ |      | $\mu\text{V}/\text{mA}$ |
|           |                              | Due to Powering Down (per Channel)                                                           |   |     | $\pm 7$   |      | $\mu\text{V}$           |
| $I_{SC}$  | Short-Circuit Output Current | $V_{CC} = 5.5\text{V}$ , $V_{REF} = 5.5\text{V}$                                             |   |     |           |      |                         |
|           |                              | Code: Zero-Scale; Forcing Output to $V_{CC}$                                                 | ● | 15  | 34        | 60   | mA                      |
|           |                              | Code: Full-Scale; Forcing Output to GND                                                      | ● | 15  | 34        | 60   | mA                      |
|           |                              | $V_{CC} = 2.7\text{V}$ , $V_{REF} = 2.7\text{V}$                                             |   |     |           |      |                         |
|           |                              | Code: Zero-Scale; Forcing Output to $V_{CC}$                                                 | ● | 7.5 | 20        | 50   | mA                      |
|           |                              | Code: Full-Scale; Forcing Output to GND                                                      | ● | 7.5 | 27        | 50   | mA                      |

#### Reference Input

|           |                                    |                  |   |    |       |          |               |
|-----------|------------------------------------|------------------|---|----|-------|----------|---------------|
|           | Input Voltage Range                |                  | ● | 0  |       | $V_{CC}$ | V             |
|           | Resistance                         | Normal Mode      | ● | 11 | 16    | 20       | k $\Omega$    |
|           | Capacitance                        |                  |   |    | 90    |          | pF            |
| $I_{REF}$ | Reference Current, Power-Down Mode | DAC Powered Down | ● |    | 0.001 | 1        | $\mu\text{A}$ |

#### Power Supply

|          |                         |                                                 |   |     |      |     |               |
|----------|-------------------------|-------------------------------------------------|---|-----|------|-----|---------------|
| $V_{CC}$ | Positive Supply Voltage | For Specified Performance                       | ● | 2.7 |      | 5.5 | V             |
| $I_{CC}$ | Supply Current          | $V_{CC} = 5\text{V}$ (Note 3)                   | ● |     | 2.50 | 4.0 | mA            |
|          |                         | $V_{CC} = 3\text{V}$ (Note 3)                   | ● |     | 2.00 | 3.2 | mA            |
|          |                         | DAC Powered Down (Note 3), $V_{CC} = 5\text{V}$ | ● |     | 0.38 | 1.0 | $\mu\text{A}$ |
|          |                         | DAC Powered Down (Note 3), $V_{CC} = 3\text{V}$ | ● |     | 0.16 | 1.0 | $\mu\text{A}$ |

# LTC2605/LTC2615/LTC2625

**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . REF = 4.096V ( $V_{CC} = 5\text{V}$ ), REF = 2.048V ( $V_{CC} = 2.7\text{V}$ ),  $V_{OUT}$  unloaded, unless otherwise noted. (Note 9)

| SYMBOL                      | PARAMETER                                                                                    | CONDITIONS                                                                                  | MIN | TYP           | MAX          | UNITS         |
|-----------------------------|----------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------|-----|---------------|--------------|---------------|
| <b>Digital I/O (Note 9)</b> |                                                                                              |                                                                                             |     |               |              |               |
| $V_{IL}$                    | Low Level Input Voltage (SDA and SCL)                                                        |                                                                                             | ●   |               | $0.3V_{CC}$  | V             |
| $V_{IH}$                    | High Level Input Voltage (SDA and SCL)                                                       |                                                                                             | ●   | $0.7V_{CC}$   |              | V             |
| $V_{IL(CA)}$                | Low Level Input Voltage (CA0 to CA2)                                                         | See Test Circuit 1                                                                          | ●   |               | $0.15V_{CC}$ | V             |
| $V_{IH(CA)}$                | High Level Input Voltage (CA0 to CA2)                                                        | See Test Circuit 1                                                                          | ●   | $0.85V_{CC}$  |              | V             |
| $R_{INH}$                   | Resistance from $C_{An}$ ( $n = 0, 1, 2$ ) to $V_{CC}$ to Set $C_{An} = V_{CC}$              | See Test Circuit 2                                                                          | ●   |               | 10           | $k\Omega$     |
| $R_{INL}$                   | Resistance from $C_{An}$ ( $n = 0, 1, 2$ ) to GND to Set $C_{An} = \text{GND}$               | See Test Circuit 2                                                                          | ●   |               | 10           | $k\Omega$     |
| $R_{INF}$                   | Resistance from $C_{An}$ ( $n = 0, 1, 2$ ) to $V_{CC}$ or GND to Set $C_{An} = \text{FLOAT}$ | See Test Circuit 2                                                                          | ●   | 2             |              | $M\Omega$     |
| $V_{OL}$                    | Low Level Output Voltage                                                                     | Sink Current = 3mA                                                                          | ●   | 0             | 0.4          | V             |
| $t_{OF}$                    | Output Fall Time                                                                             | $V_O = V_{IH(MIN)}$ to $V_O = V_{IL(MAX)}$ , $C_B = 10\text{pF}$ to $400\text{pF}$ (Note 7) | ●   | $20 + 0.1C_B$ | 250          | ns            |
| $t_{SP}$                    | Pulse Width of Spikes Surpassed by Input Filter                                              |                                                                                             | ●   | 0             | 50           | ns            |
| $I_{IN}$                    | Input Leakage                                                                                | $0.1V_{CC} \leq V_{IN} \leq 0.9V_{CC}$                                                      | ●   |               | 1            | $\mu\text{A}$ |
| $C_{IN}$                    | I/O Pin Capacitance                                                                          | (Note 12)                                                                                   | ●   |               | 10           | pF            |
| $C_B$                       | Capacitance Load for Each Bus Line                                                           |                                                                                             | ●   |               | 400          | pF            |
| $C_{CAn}$                   | External Capacitive Load on Address Pins CA0, CA1 and CA2                                    |                                                                                             | ●   |               | 10           | pF            |

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . REF = 4.096V ( $V_{CC} = 5\text{V}$ ), REF = 2.048V ( $V_{CC} = 2.7\text{V}$ ),  $V_{OUT}$  unloaded, unless otherwise noted.

| SYMBOL         | PARAMETER                            | CONDITIONS                  | LTC2625/LTC2625-1 |     |     | LTC2615/LTC2615-1 |     |     | LTC2605/LTC2605-1 |     |     | UNITS             |     |    |
|----------------|--------------------------------------|-----------------------------|-------------------|-----|-----|-------------------|-----|-----|-------------------|-----|-----|-------------------|-----|----|
|                |                                      |                             | MIN               | TYP | MAX | MIN               | TYP | MAX | MIN               | TYP | MAX |                   |     |    |
| AC Performance |                                      |                             |                   |     |     |                   |     |     |                   |     |     |                   |     |    |
| t <sub>S</sub> | Settling Time (Note 5)               | ±0.024% (±1LSB at 12 Bits)  | 7                 |     |     | 7                 |     |     | 7                 |     |     | μs                |     |    |
|                |                                      | ±0.006% (±1LSB at 14 Bits)  |                   |     |     |                   |     |     |                   |     |     | 9                 | 9   | μs |
|                |                                      | ±0.0015% (±1LSB at 16 Bits) |                   |     |     |                   |     |     |                   |     |     | 10                | μs  |    |
|                | Settling Time for 1LSB Step (Note 6) | ±0.024% (±1LSB at 12 Bits)  | 2.7               |     |     | 2.7               |     |     | 2.7               |     |     | μs                |     |    |
|                |                                      | ±0.006% (±1LSB at 14 Bits)  |                   |     |     |                   |     |     |                   |     |     | 4.8               | 4.8 | μs |
|                |                                      | ±0.0015% (±1LSB at 16 Bits) |                   |     |     |                   |     |     |                   |     |     | 5.2               | μs  |    |
|                | Voltage Output Slew Rate             |                             | 0.80              |     |     | 0.80              |     |     | 0.80              |     |     | V/μs              |     |    |
|                | Capacitive Load Driving              |                             | 1000              |     |     | 1000              |     |     | 1000              |     |     | pF                |     |    |
|                | Glitch Inpulse                       | At Mid-Scale Transition     | 12                |     |     | 12                |     |     | 12                |     |     | nV•s              |     |    |
|                | Multiplying Bandwidth                |                             | 180               |     |     | 180               |     |     | 180               |     |     | kHz               |     |    |
| e <sub>n</sub> | Output Voltage Noise Density         | At f = 1kHz                 | 120               |     |     | 120               |     |     | 120               |     |     | nV/√Hz            |     |    |
|                |                                      | At f = 10kHz                | 100               |     |     | 100               |     |     | 100               |     |     | nV/√Hz            |     |    |
|                | Output Voltage Noise                 | 0.1Hz to 10Hz               | 15                |     |     | 15                |     |     | 15                |     |     | μV <sub>P-P</sub> |     |    |

## TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . See Figure 1. (Notes 8, 9)

| SYMBOL                                                               | PARAMETER                                        | CONDITIONS | MIN           | TYP | MAX | UNITS         |
|----------------------------------------------------------------------|--------------------------------------------------|------------|---------------|-----|-----|---------------|
| <b><math>V_{CC} = 2.7\text{V}</math> to <math>5.5\text{V}</math></b> |                                                  |            |               |     |     |               |
| $f_{SCL}$                                                            | SCL Clock Frequency                              | ●          | 0             |     | 400 | kHz           |
| $t_{HD(STA)}$                                                        | Hold Time (Repeated) Start Condition             | ●          | 0.6           |     |     | $\mu\text{s}$ |
| $t_{LOW}$                                                            | Low Period of the SCL Clock Pin                  | ●          | 1.3           |     |     | $\mu\text{s}$ |
| $t_{HIGH}$                                                           | High Period of the SCL Clock Pin                 | ●          | 0.6           |     |     | $\mu\text{s}$ |
| $t_{SU(STA)}$                                                        | Set-Up Time for a Repeated Start Program         | ●          | 0.6           |     |     | $\mu\text{s}$ |
| $t_{HD(DAT)}$                                                        | Data Hold Time                                   | ●          | 0             |     | 0.9 | $\mu\text{s}$ |
| $t_{SU(DAT)}$                                                        | Data Set-Up Time                                 | ●          | 100           |     |     | ns            |
| $t_r$                                                                | Rise Time of Both SDA and SCL Signals            | (Note 7)   | $20 + 0.1C_B$ |     | 300 | ns            |
| $t_f$                                                                | Fall Time of Both SDA and SCL Signals            | (Note 7)   | $20 + 0.1C_B$ |     | 300 | ns            |
| $t_{SU(STO)}$                                                        | Set-Up Time for Stop Condition                   | ●          | 0.6           |     |     | $\mu\text{s}$ |
| $t_{BUF}$                                                            | Bus Free Time Between a Stop and Start Condition | ●          | 1.3           |     |     | $\mu\text{s}$ |

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** Linearity and monotonicity are defined from code  $k_L$  to code  $2^N - 1$ , where  $N$  is the resolution and  $k_L$  is given by  $k_L = 0.016(2^N/V_{REF})$ , rounded to the nearest whole code. For  $V_{REF} = 4.096\text{V}$  and  $N = 16$ ,  $k_L = 256$  and linearity is defined from code 256 to code 65,535.

**Note 3:** SDA, SCL at 0V or  $V_{CC}$ , CA0, CA1 and CA2 floating.

**Note 4:** Inferred from measurement at code 256 (LTC2605/LTC2605-1), code 64 (LTC2615/LTC2615-1) or code 16 (LTC2625/LTC2625-1) and at full-scale.

**Note 5:**  $V_{CC} = 5\text{V}$ ,  $V_{REF} = 4.096\text{V}$ . DAC is stepped 1/4-scale to 3/4-scale and 3/4-scale to 1/4-scale. Load is  $2\text{k}\Omega$  in parallel with  $200\text{pF}$  to GND.

**Note 6:**  $V_{CC} = 5\text{V}$ ,  $V_{REF} = 4.096\text{V}$ . DAC is stepped  $\pm 1\text{LSB}$  between half-scale and half-scale  $- 1$ . Load is  $2\text{k}\Omega$  in parallel with  $200\text{pF}$  to GND.

**Note 7:**  $C_B$  = capacitance of one bus line in pF

**Note 8:** All values refer to  $V_{IH(MIN)}$  and  $V_{IL(MAX)}$  levels.

**Note 9:** These specifications apply to LTC2605/LTC2605-1, LTC2615/LTC2615-1 and LTC2625/LTC2625-1.

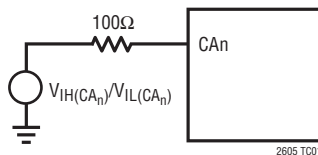
**Note 10:** DC Crosstalk is measured with  $V_{CC} = 5\text{V}$  and  $V_{REF} = 4.096\text{V}$ , with the measured DAC at mid-scale, unless otherwise noted.

**Note 11:**  $R_L = 2\text{k}\Omega$  to GND or  $V_{CC}$ .

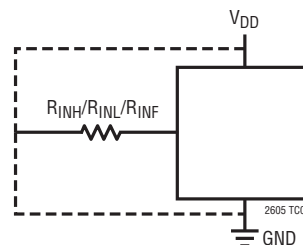
**Note 12:** Guaranteed by design and not production tested.

## ELECTRICAL CHARACTERISTICS

Test Circuit 1

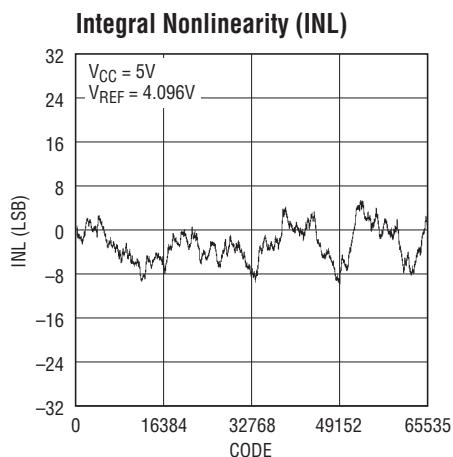


Test Circuit 2

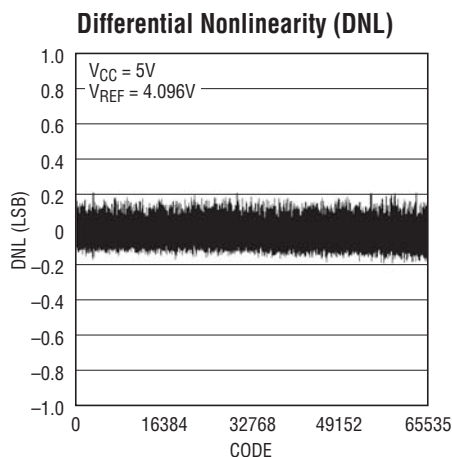


## TYPICAL PERFORMANCE CHARACTERISTICS

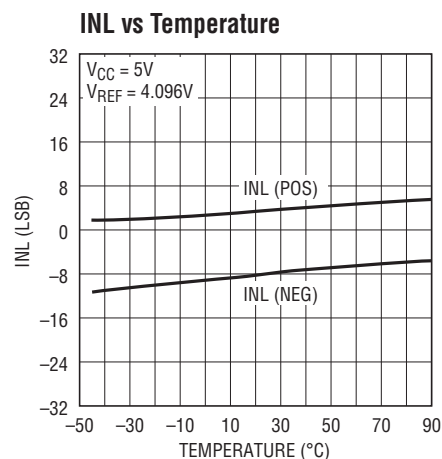
### LTC2605



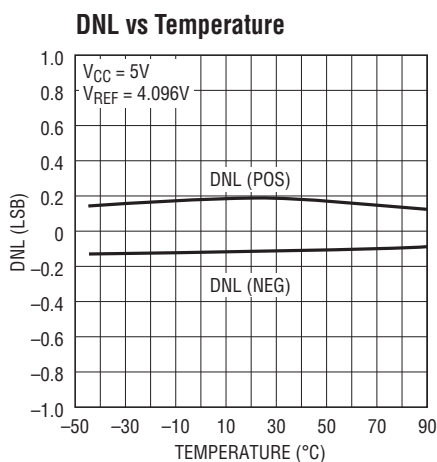
2605 G01



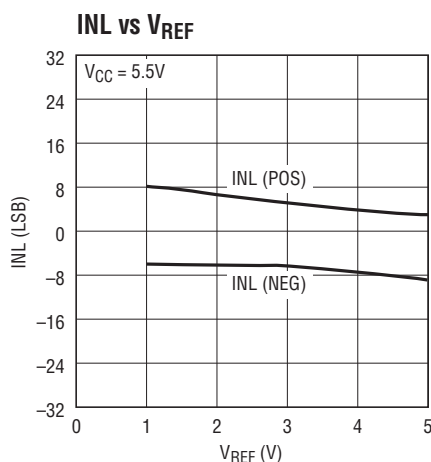
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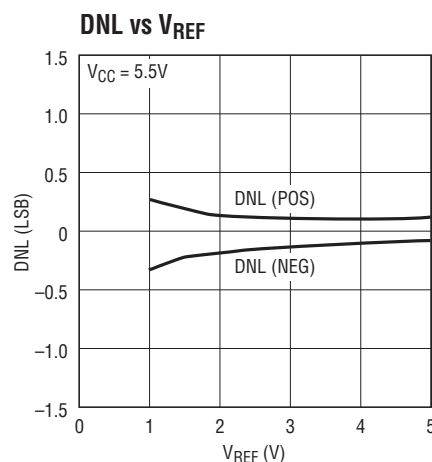
2605 G03



2605 G04

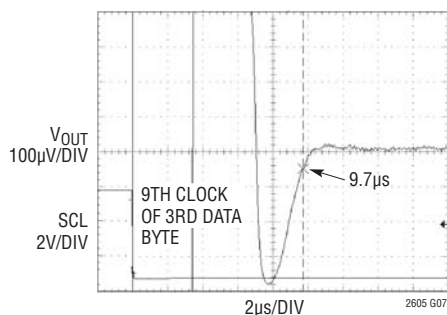


2605 G05



2605 G06

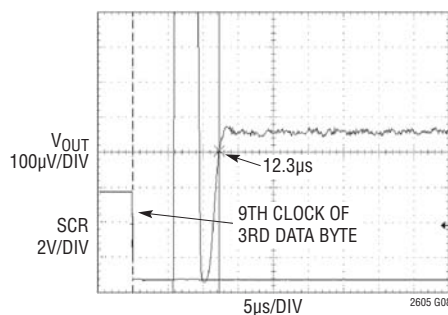
### Settling to $\pm 1LSB$



2605 G07

$V_{CC} = 5V$ ,  $V_{REF} = 4.096V$   
1/4-SCALE TO 3/4-SCALE STEP  
 $R_L = 2k$ ,  $C_L = 200pF$   
AVERAGE OF 2048 EVENTS

### Settling of Full-Scale Step

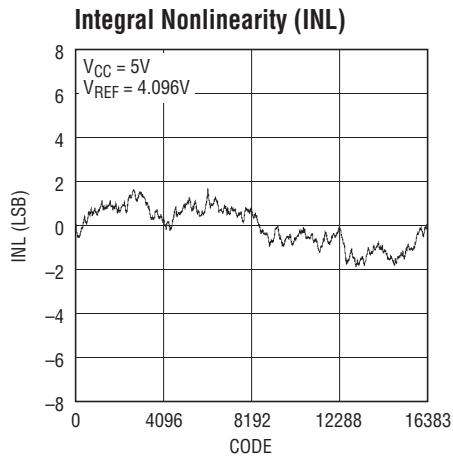


2605 G08

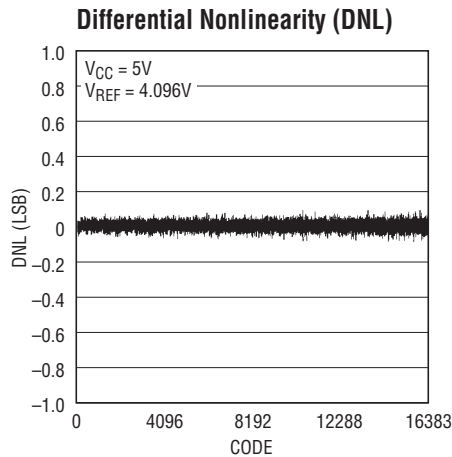
SETTLING TO  $\pm 1LSB$   
 $V_{CC} = 5V$ ,  $V_{REF} = 4.096V$   
CODE 512 TO 65535 STEP  
AVERAGE OF 2048 EVENTS

# TYPICAL PERFORMANCE CHARACTERISTICS

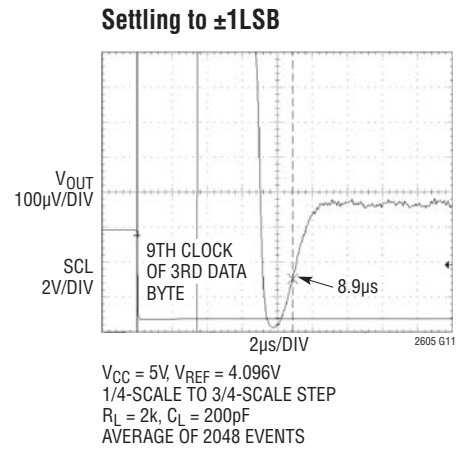
## LTC2615



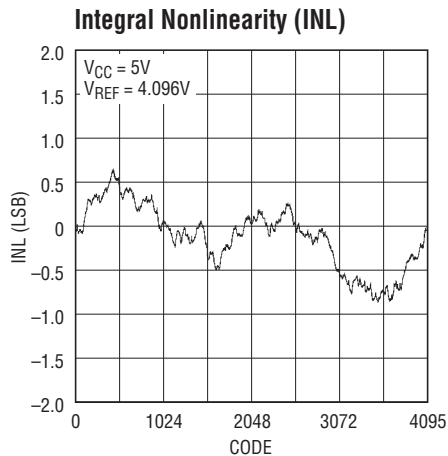
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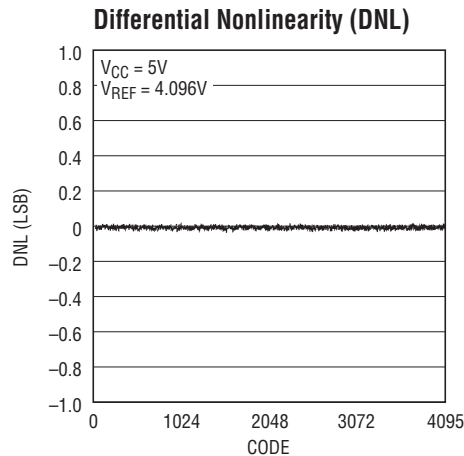
2605 G10



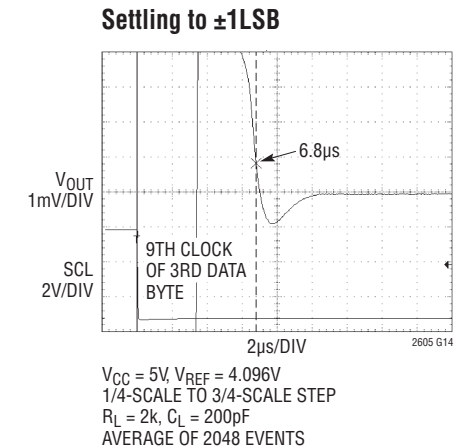
## LTC2625



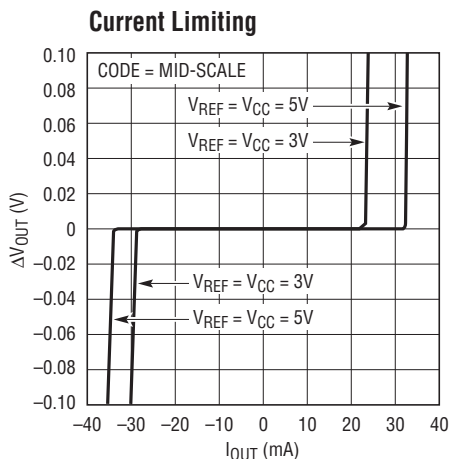
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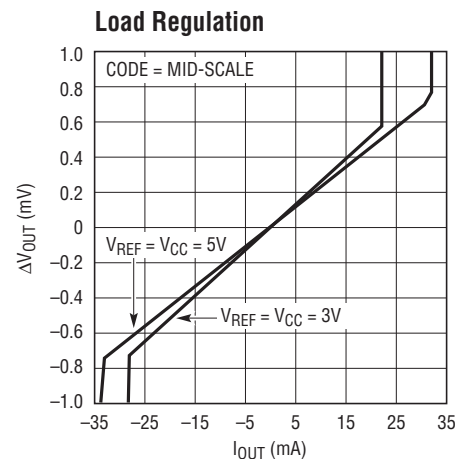
2605 G13



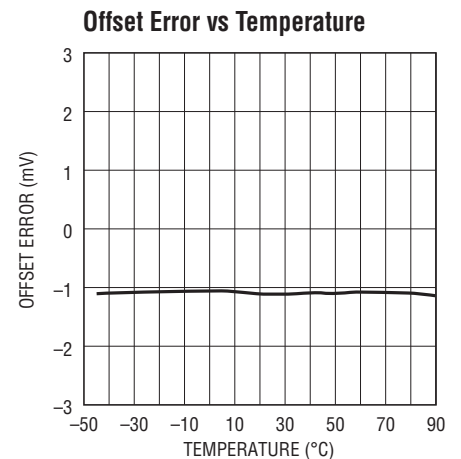
## LTC2605/LTC2615/LTC2625



2605 G15



2605 G16



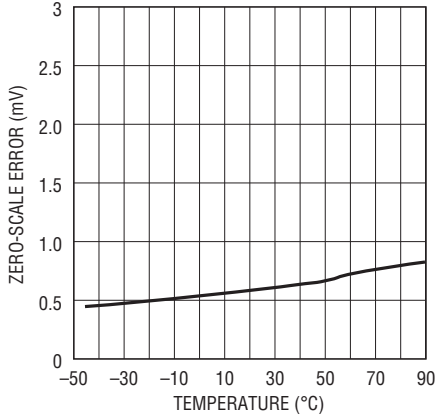
2605 G17

# LTC2605/LTC2615/LTC2625

## TYPICAL PERFORMANCE CHARACTERISTICS

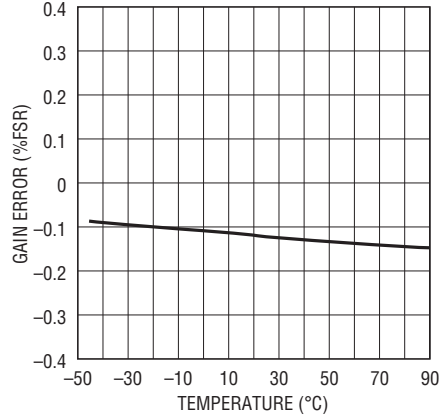
LTC2605/LTC2615/LTC2625

Zero-Scale Error vs Temperature



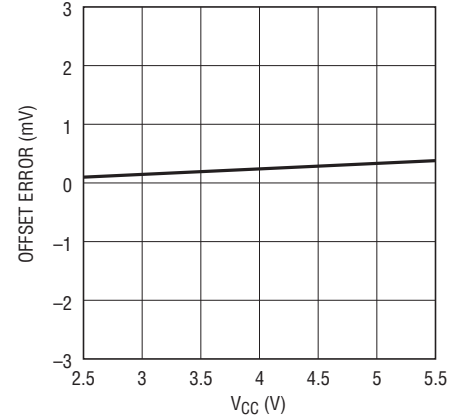
2605 G18

Gain Error vs Temperature



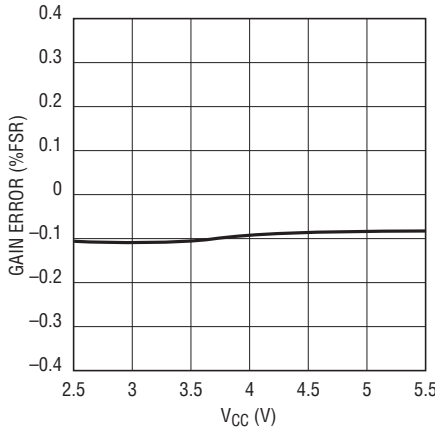
2605 G19

Offset Error vs  $V_{CC}$



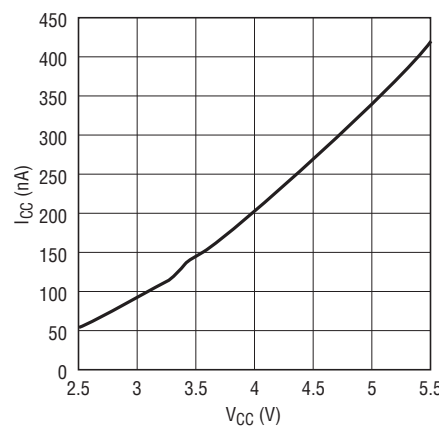
2605 G20

Gain Error vs  $V_{CC}$



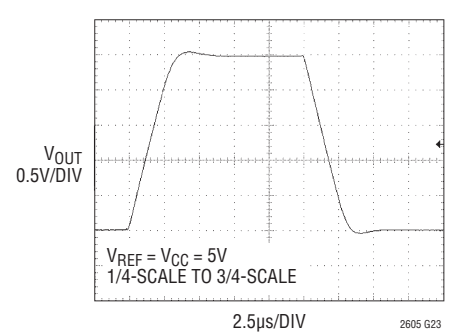
2605 G21

$I_{CC}$  Shutdown vs  $V_{CC}$



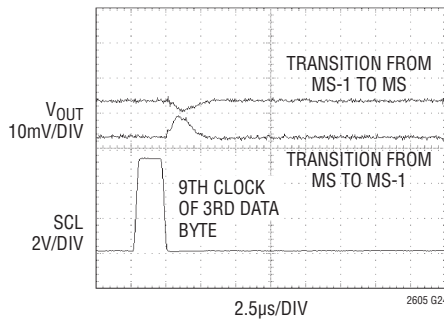
2605 G22

Large-Signal Response



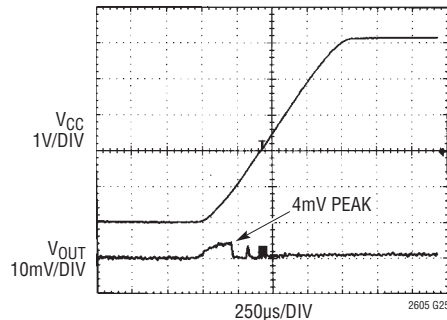
2605 G23

Mid-Scale Glitch Impulse



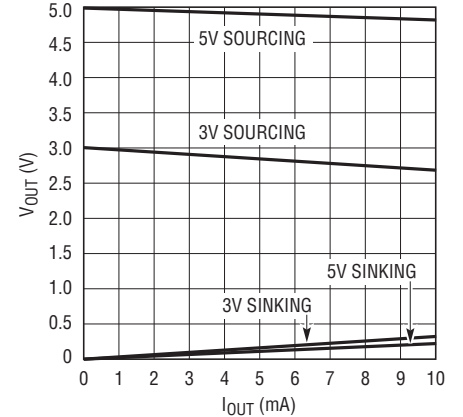
2605 G24

Power-On Reset Glitch



2605 G25

Headroom at Rails vs Output Current



2605 G26

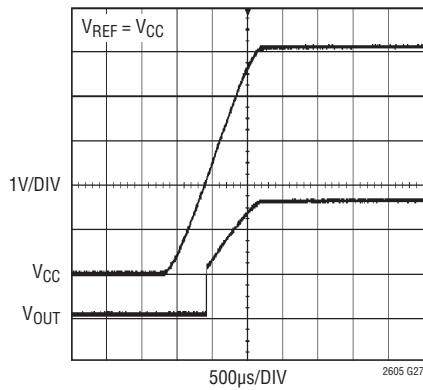
2605fa



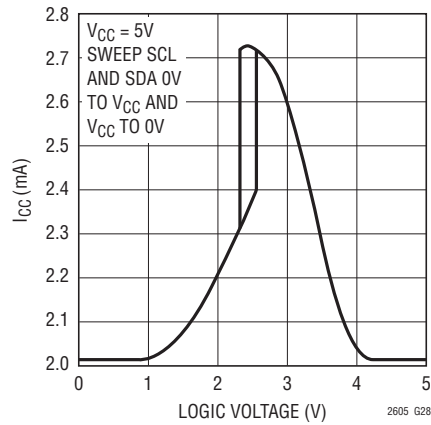
## TYPICAL PERFORMANCE CHARACTERISTICS

LTC2605/LTC2615/LTC2625

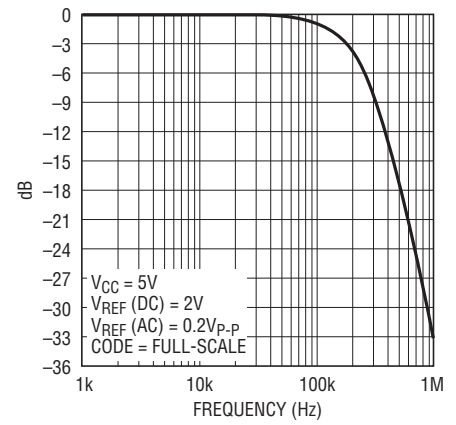
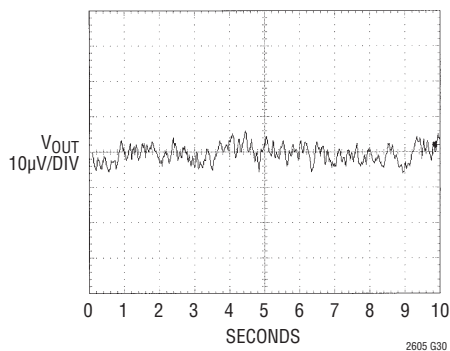
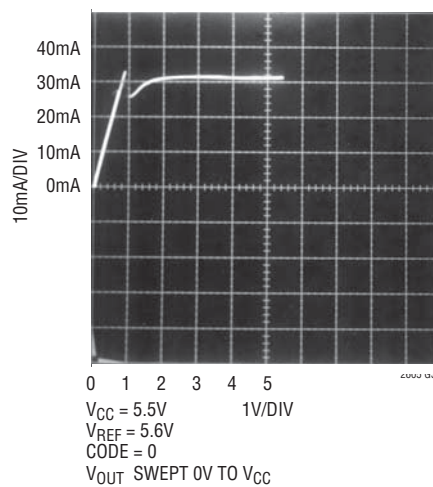
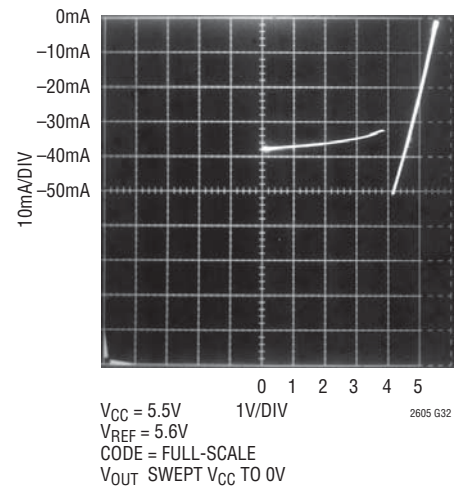
Power-On Reset to Mid-Scale



Supply Current vs Logic Voltage



Multiplying Bandwidth

Output Voltage Noise,  
0.1Hz to 10HzShort-Circuit Output Current  
vs VOUT (Sinking)Short-Circuit Output Current  
vs VOUT (Sourcing)

## PIN FUNCTIONS

**GND (Pin 1):** Analog Ground.

**V<sub>OUT A</sub> to V<sub>OUT H</sub> (Pins 2-5 and 12-15):** DAC Analog Voltage Output. The output range is 0V to V<sub>REF</sub>.

**REF (Pin 6):** Reference Voltage Input.  $0V \leq V_{REF} \leq V_{CC}$ .

**CA2 (Pin 7):** Chip Address Bit 2. Tie this pin to V<sub>CC</sub>, GND or leave it floating to select an I<sup>2</sup>C slave address for the part (Table 2).

**SCL (Pin 8):** Serial Clock Input Pin. Data is shifted into the SDA pin at the rising edges of the clock. This high impedance pin requires a pull-up resistor or current source to V<sub>CC</sub>.

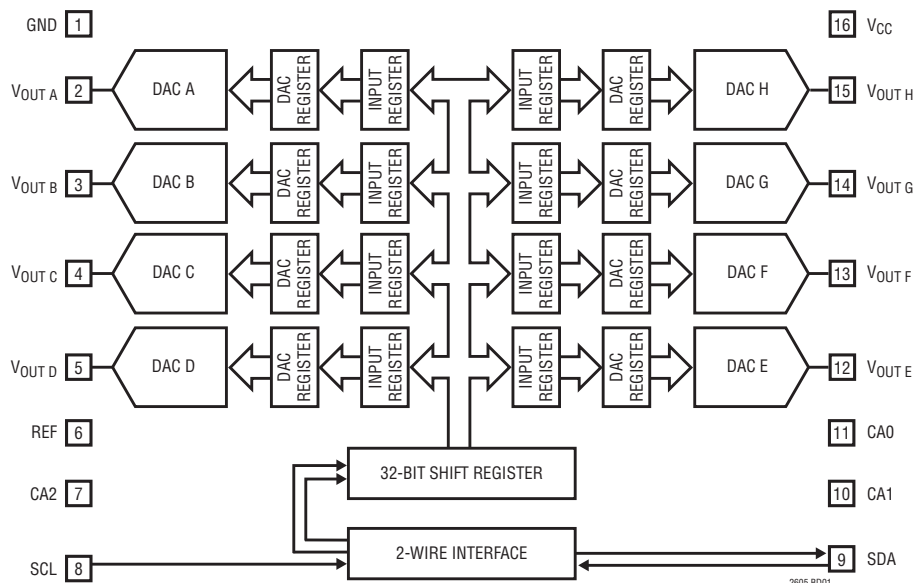
**SDA (Pin 9):** Serial Data Bidirectional Pin. Data is shifted into the SDA pin and acknowledged by the SDA pin. This is a high impedance pin while data is shifted in. It is an open-drain N-channel output during acknowledgment. This pin requires a pull-up resistor or current source to V<sub>CC</sub>.

**CA1 (Pin 10):** Chip Address Bit 1. Tie this pin to V<sub>CC</sub>, GND or leave it floating to select an I<sup>2</sup>C slave address for the part (Table 2).

**CA0 (Pin 11):** Chip Address Bit 0. Tie this pin to V<sub>CC</sub>, GND or leave it floating to select an I<sup>2</sup>C slave address for the part (Table 2).

**V<sub>CC</sub> (Pin 16):** Supply Voltage Input.  $2.7V \leq V_{CC} \leq 5.5V$ .

## BLOCK DIAGRAM



## TIMING DIAGRAM

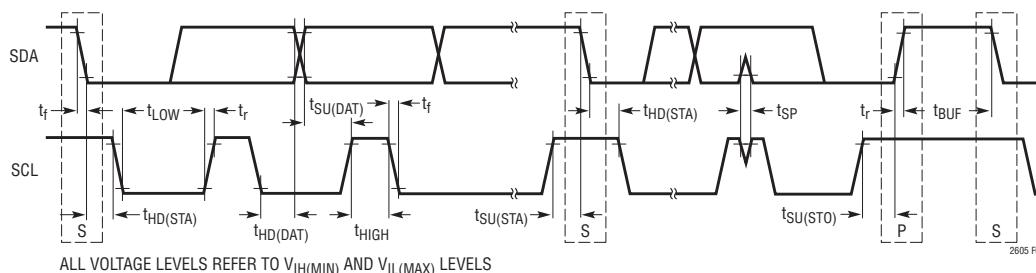


Figure 1

## OPERATION

### Power-On Reset

The LTC2605/LTC2615/LTC2625 clear the outputs to zero-scale when power is first applied, making system initialization consistent and repeatable. The LTC2605-1/LTC2615-1/LTC2625-1 set the voltage outputs to mid-scale when power is first applied.

For some applications, downstream circuits are active during DAC power-up, and may be sensitive to nonzero outputs from the DAC during this time. The LTC2605/LTC2615/LTC2625 contain circuitry to reduce the power-on glitch: the analog outputs typically rise less than 10mV above zero-scale during power on if the power supply is ramped to 5V in 1ms or more. In general, the glitch amplitude decreases as the power supply ramp time is increased. See Power-On Reset Glitch in the Typical Performance Characteristics section.

### Power Supply Sequencing

The voltage at REF (Pin 6) should be kept within the range  $-0.3V \leq V_{REF} \leq V_{CC} + 0.3V$  (see Absolute Maximum Ratings). Particular care should be taken to observe these limits during power supply turn-on and turn-off sequences, when the voltage at  $V_{CC}$  (Pin 16) is in transition.

### Transfer Function

The digital-to-analog transfer function is:

$$V_{OUT(IDEAL)} = \left( \frac{k}{2^N} \right) V_{REF}$$

Table 1

| COMMAND* |    |    |    |                                                    |
|----------|----|----|----|----------------------------------------------------|
| C3       | C2 | C1 | C0 |                                                    |
| 0        | 0  | 0  | 0  | Write to Input Register n                          |
| 0        | 0  | 0  | 1  | Update (Power Up) DAC Register n                   |
| 0        | 0  | 1  | 0  | Write to Input Register n, Update (Power Up) All n |
| 0        | 0  | 1  | 1  | Write to and Update (Power Up) n                   |
| 0        | 1  | 0  | 0  | Power Down n                                       |
| 1        | 1  | 1  | 1  | No Operation                                       |

\*Address and command codes not shown are reserved and should not be used.

where k is the decimal equivalent of the binary DAC input code, N is the resolution and  $V_{REF}$  is the voltage at REF (Pin 6).

### Serial Digital Interface

The LTC2605/LTC2615/LTC2625 communicate with a host using the standard 2-wire digital interface. The Timing Diagram (Figure 1) shows the timing relationship of the signals on the bus. The two bus lines, SDA and SCL, must be high when the bus is not in use. External pull-up resistors or current sources are required on these lines. The value of these pull-up resistors is dependent on the power supply and can be obtained from the I<sup>2</sup>C specifications. For an I<sup>2</sup>C bus operating in the fast mode, an active pull-up will be necessary if the bus capacitance is greater than 200pF. The  $V_{CC}$  power should not be removed from the LTC2605/LTC2615/LTC2625 when the I<sup>2</sup>C bus is active to avoid loading the I<sup>2</sup>C bus lines through the internal ESD protection diodes.

The LTC2605/LTC2615/LTC2625 are receive-only (slave) devices. The master can write to the LTC2605/LTC2615/LTC2625. The LTC2605/LTC2615/LTC2625 do not respond to a read from the master.

### The START (S) and STOP (P) Conditions

When the bus is not in use, both SCL and SDA must be high. A bus master signals the beginning of a communication to a slave device by transmitting a START condition. A START condition is generated by transitioning SDA from high to low while SCL is high.

| ADDRESS (n)* |    |    |    |          |
|--------------|----|----|----|----------|
| A3           | A2 | A1 | A0 |          |
| 0            | 0  | 0  | 0  | DAC A    |
| 0            | 0  | 0  | 1  | DAC B    |
| 0            | 0  | 1  | 0  | DAC C    |
| 0            | 0  | 1  | 1  | DAC D    |
| 0            | 1  | 0  | 0  | DAC E    |
| 0            | 1  | 0  | 1  | DAC F    |
| 0            | 1  | 1  | 0  | DAC G    |
| 0            | 1  | 1  | 1  | DAC H    |
| 1            | 1  | 1  | 1  | All DACs |

## OPERATION

When the master has finished communicating with the slave, it issues a STOP condition. A STOP condition is generated by transitioning SDA from low to high while SCL is high. The bus is then free for communication with another I<sup>2</sup>C device.

### Acknowledge

The Acknowledge signal is used for handshaking between the master and the slave. An Acknowledge (active LOW) generated by the slave lets the master know that the latest byte of information was received. The Acknowledge related clock pulse is generated by the master. The master releases the SDA line (HIGH) during the Acknowledge clock pulse. The slave-receiver must pull down the SDA during the Acknowledge clock pulse so that it remains a stable LOW during the HIGH period of this clock pulse. The LTC2605/LTC2615/LTC2625 respond to a write by a master in this manner. The LTC2605/LTC2615/LTC2625 do not acknowledge a read (it retains SDA HIGH during the period of the Acknowledge clock pulse).

### Chip Address

The state of CA0, CA1 and CA2 decides the slave address of the part. The pins CA0, CA1 and CA2 can be each set to any one of three states: V<sub>CC</sub>, GND or FLOAT. This results in 27 selectable addresses for the part. The addresses corresponding to the states of CA0, CA1 and CA2 and the global address are shown in Table 2.

In addition to the address selected by the address pins, the parts also respond to a global address. This address allows a common write to all LTC2605, LTC2615 and LTC2625 parts to be accomplished with one 3-byte write transaction on the I<sup>2</sup>C bus. The global address is a 7-bit hard-wired address and is not selectable by CA0, CA1 and CA2. The maximum capacitive load allowed on the address pins (CA0, CA1 and CA2) is 10pF.

### Write Word Protocol

The master initiates communication with the LTC2605/LTC2615/LTC2625 with a START condition and a 7-bit slave address followed by the Write bit (W) = 0. The LTC2605/LTC2615/LTC2625 acknowledges by pulling the SDA pin

Table 2. Slave Address Map

| CA2             | CA1             | CA0             | SA6 | SA5 | SA4 | SA3 | SA2 | SA1 | SA0 |
|-----------------|-----------------|-----------------|-----|-----|-----|-----|-----|-----|-----|
| GND             | GND             | GND             | 0   | 0   | 1   | 0   | 0   | 0   | 0   |
| GND             | GND             | FLOAT           | 0   | 0   | 1   | 0   | 0   | 0   | 1   |
| GND             | GND             | V <sub>CC</sub> | 0   | 0   | 1   | 0   | 0   | 1   | 0   |
| GND             | FLOAT           | GND             | 0   | 0   | 1   | 0   | 0   | 1   | 1   |
| GND             | FLOAT           | FLOAT           | 0   | 1   | 0   | 0   | 0   | 0   | 0   |
| GND             | FLOAT           | V <sub>CC</sub> | 0   | 1   | 0   | 0   | 0   | 0   | 1   |
| GND             | V <sub>CC</sub> | GND             | 0   | 1   | 0   | 0   | 0   | 1   | 0   |
| GND             | V <sub>CC</sub> | FLOAT           | 0   | 1   | 0   | 0   | 0   | 1   | 1   |
| GND             | V <sub>CC</sub> | V <sub>CC</sub> | 0   | 1   | 1   | 0   | 0   | 0   | 0   |
| FLOAT           | GND             | GND             | 0   | 1   | 1   | 0   | 0   | 0   | 1   |
| FLOAT           | GND             | FLOAT           | 0   | 1   | 1   | 0   | 0   | 1   | 0   |
| FLOAT           | GND             | V <sub>CC</sub> | 0   | 1   | 1   | 0   | 0   | 1   | 1   |
| FLOAT           | FLOAT           | GND             | 1   | 0   | 0   | 0   | 0   | 0   | 0   |
| FLOAT           | FLOAT           | FLOAT           | 1   | 0   | 0   | 0   | 0   | 0   | 1   |
| FLOAT           | FLOAT           | V <sub>CC</sub> | 1   | 0   | 0   | 0   | 0   | 1   | 0   |
| FLOAT           | V <sub>CC</sub> | GND             | 1   | 0   | 0   | 0   | 0   | 1   | 1   |
| FLOAT           | V <sub>CC</sub> | FLOAT           | 1   | 0   | 1   | 0   | 0   | 0   | 0   |
| FLOAT           | V <sub>CC</sub> | V <sub>CC</sub> | 1   | 0   | 1   | 0   | 0   | 0   | 1   |
| V <sub>CC</sub> | GND             | GND             | 1   | 0   | 1   | 0   | 0   | 1   | 0   |
| V <sub>CC</sub> | GND             | FLOAT           | 1   | 0   | 1   | 0   | 0   | 1   | 1   |
| V <sub>CC</sub> | GND             | V <sub>CC</sub> | 1   | 1   | 0   | 0   | 0   | 0   | 0   |
| V <sub>CC</sub> | FLOAT           | GND             | 1   | 1   | 0   | 0   | 0   | 0   | 1   |
| V <sub>CC</sub> | FLOAT           | FLOAT           | 1   | 1   | 0   | 0   | 0   | 1   | 0   |
| V <sub>CC</sub> | FLOAT           | V <sub>CC</sub> | 1   | 1   | 0   | 0   | 0   | 1   | 1   |
| V <sub>CC</sub> | V <sub>CC</sub> | GND             | 1   | 1   | 1   | 0   | 0   | 0   | 0   |
| V <sub>CC</sub> | V <sub>CC</sub> | FLOAT           | 1   | 1   | 1   | 0   | 0   | 0   | 1   |
| V <sub>CC</sub> | V <sub>CC</sub> | V <sub>CC</sub> | 1   | 1   | 1   | 0   | 0   | 1   | 0   |
| GLOBAL ADDRESS  |                 |                 | 1   | 1   | 1   | 0   | 0   | 1   | 1   |

low at the 9th clock if the 7-bit slave address matches the address of the parts (set by CA0, CA1 and CA2) or the global address. The master then transmits three bytes of data. The LTC2605/LTC2615/LTC2625 acknowledges each byte of data by pulling the SDA line low at the 9th clock of each data byte transmission. After receiving three complete bytes of data, the LTC2605/LTC2615/LTC2625 executes the command specified in the 24-bit input word.

If more than three data bytes are transmitted after a valid 7-bit slave address, the LTC2605/LTC2615/LTC2625 do not acknowledge the extra bytes of data (SDA is high during the 9th clock).

## OPERATION

### WRITE WORD PROTOCOL FOR LTC2605/LTC2615/LTC2625

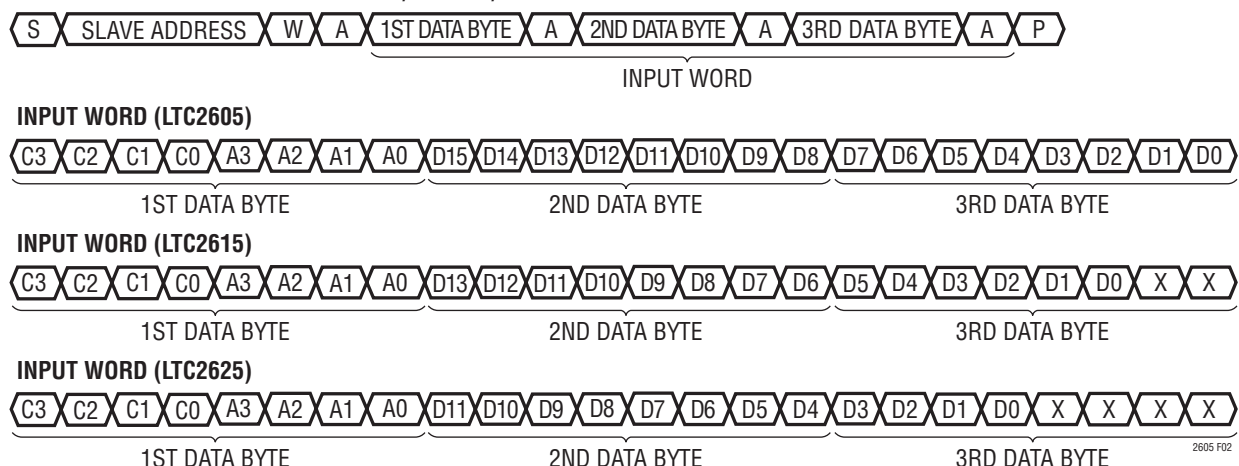


Figure 2

The format of the three data bytes is shown in Figure 2. The first byte of the input word consists of the 4-bit command and 4-bit DAC address. The next two bytes consist of the 16-bit data word. The 16-bit data word consists of the 16-, 14- or 12-bit input code, MSB to LSB, followed by 0, 2 or 4 don't care bits (LTC2605, LTC2615 and LTC2625 respectively). A typical I<sup>2</sup>C write transaction is shown in Figure 3.

The command (C3-C0) and address (A3-A0) assignments are shown in Table 1. The first four commands in the table consist of write and update operations. A write operation loads the 16-bit data word from the 32-bit shift register into the input register of the selected DAC, *n*. An update operation copies the data word from the input register to the DAC register. Once copied into the DAC register, the data word becomes the active 16-, 14- or 12-bit input code, and is converted to an analog voltage at the DAC output. The update operation also powers up the selected DAC if it had been in power-down mode. The data path and registers are shown in the Block Diagram.

### Power-Down Mode

For power-constrained applications, power-down mode can be used to reduce the supply current whenever less than eight outputs are needed. When in power down, the buffer amplifiers and reference inputs are disabled and draw essentially zero current. The DAC outputs are put into

a high impedance state, and the output pins are passively pulled to ground through individual 90k resistors. When all eight DACs are powered down, the bias generation circuit is also disabled. Input and DAC registers are not disturbed during power down.

Any channel or combination of channels can be put into power-down mode by using command 0100<sub>b</sub> in combination with the appropriate DAC address, (*n*). The 16-bit data word is ignored. The supply and reference currents are reduced by approximately 1/8 for each DAC powered down; the effective resistance at REF (Pin 6) rises accordingly, becoming a high impedance input (typically >1GΩ) when all eight DACs are powered down.

Normal operation can be resumed by executing any command which includes a DAC update, as shown in Table 1. The selected DAC is powered up as its voltage output is updated.

There is an initial delay as the DAC powers up before it begins its usual settling behavior. If less than eight DACs are in a powered-down state prior to the updated command, the power-up delay is 5μs. If, on the other hand, all eight DACs are powered down, then the bias generation circuit is also disabled and must be restarted. In this case, the power-up delay is greater: 12μs for V<sub>CC</sub> = 5V, 30μs for V<sub>CC</sub> = 3V.

OPERATION

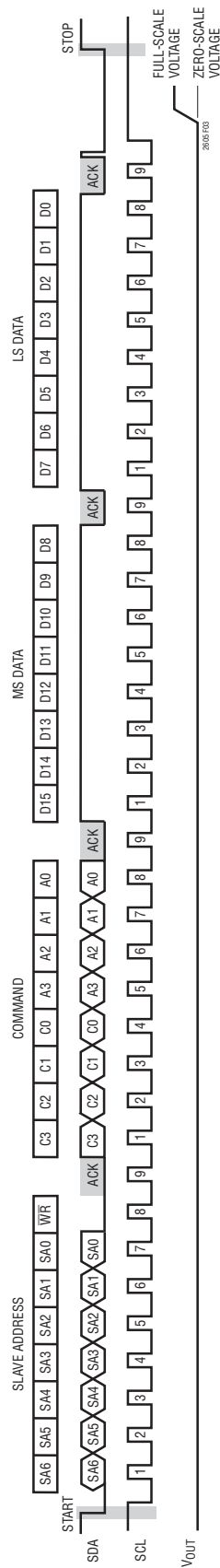


Figure 3. Typical LTC2605 Input Waveform—Programming DAC Output for Full-Scale



## OPERATION

### Voltage Outputs

Each of the eight rail-to-rail amplifiers contained in these parts has guaranteed load regulation when sourcing or sinking up to 15mA at 5V (7.5mA at 3V).

Load regulation is a measure of the amplifier's ability to maintain the rated voltage accuracy over a wide range of load conditions. The measured change in output voltage per milliampere of forced load current change is expressed in LSB/mA.

DC output impedance is equivalent to load regulation and may be derived from it by simply calculating a change in units from LSB/mA to Ohms. The amplifier's DC output impedance is  $0.020\Omega$  when driving a load well away from the rails.

When drawing a load current from either rail, the output voltage headroom with respect to that rail is limited by the  $30\Omega$  typical channel resistance of the output devices; e.g., when sinking 1mA, the minimum output voltage =  $30\Omega \cdot 1\text{mA} = 30\text{mV}$ . See the graph Headroom at Rails vs Output Current in the Typical Performance Characteristics section.

The amplifiers are stable driving capacitive loads of up to 1000pF.

### Board Layout

The excellent load regulation and DC-crosstalk performance of these devices is achieved in part by keeping "signal" and "power" grounds separated internally and by reducing shared internal resistance to just  $0.005\Omega$ .

The GND pin functions both as the node to which the reference and output voltages are referred and as a return path for power currents in the device. Because of this, careful thought should be given to the grounding scheme and board layout in order to ensure rated performance.

The PC board should have separate areas for the analog and digital sections of the circuit. This keeps digital signals away from sensitive analog signals and facilitates the use of separate digital and analog ground planes which have minimal capacitive and resistive interaction with each other.

Digital and analog ground planes should be joined at only one point, establishing a system star ground as close to the device's ground pin as possible. Ideally, the analog ground plane should be located on the component side of the board, and should be allowed to run under the part to shield it from noise. Analog ground should be a continuous and uninterrupted plane, except for necessary lead pads and vias, with signal traces on another layer.

The GND pin of the part should be connected to analog ground. Resistance from the GND pin to system star ground should be as low as possible. Resistance here will add directly to the effective DC output impedance of the device (typically  $0.020\Omega$ ), and will degrade DC crosstalk. Note that the LTC2605/LTC2615/LTC2625 are no more susceptible to these effects than other parts of their type; on the contrary, they allow layout-based performance improvements to shine rather than limiting attainable performance with excessive internal resistance.

### Rail-to-Rail Output Considerations

In any rail-to-rail voltage output device, the output is limited to voltages within the supply range.

Since the analog outputs of the device cannot go below ground, they may limit for the lowest codes as shown in Figure 4b. Similarly, limiting can occur near full-scale when the REF pin is tied to  $V_{CC}$ . If  $V_{REF} = V_{CC}$  and the DAC full-scale error (FSE) is positive, the output for the highest codes limits at  $V_{CC}$  as shown in Figure 4c. No full-scale limiting can occur if  $V_{REF}$  is less than  $V_{CC} - \text{FSE}$ .

Offset and linearity are defined and tested over the region of the DAC transfer function where no output limiting can occur.

# OPERATION

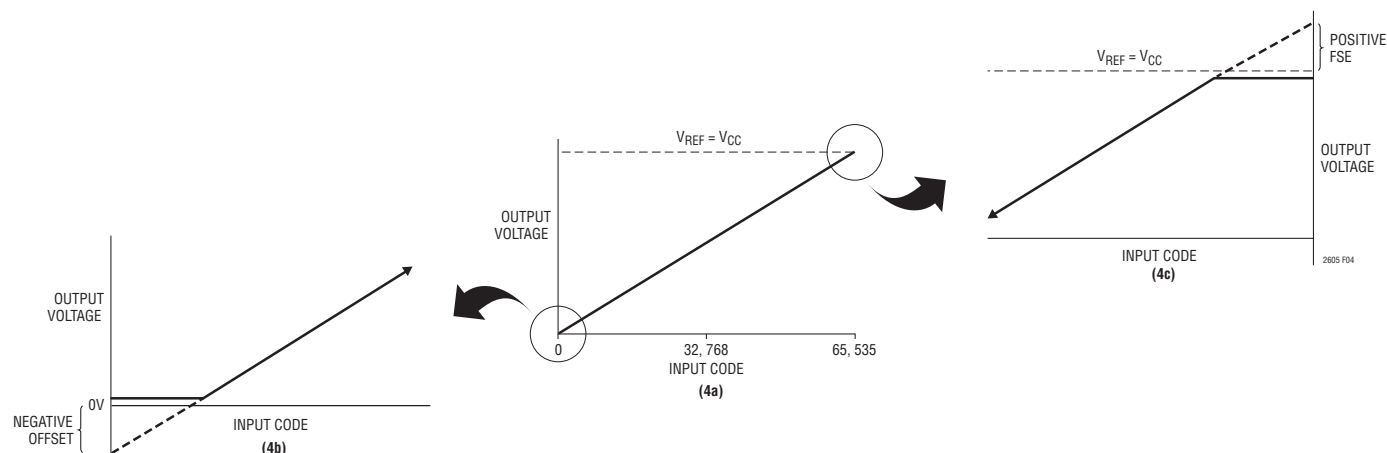
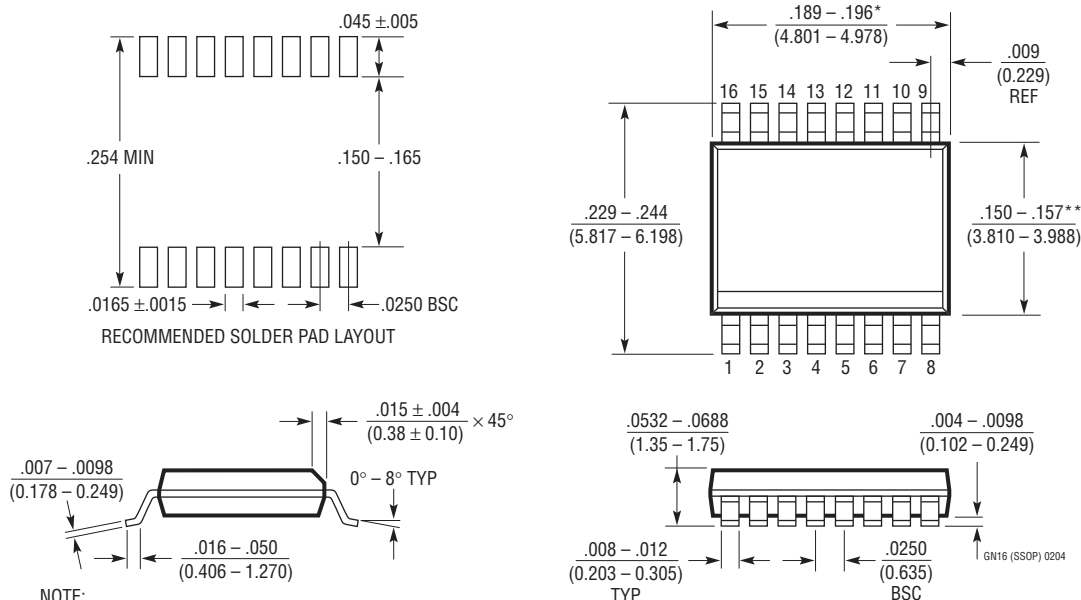


Figure 4. Effects of Rail-to-Rail Operation on a DAC Transfer Curve. (4a) Overall Transfer Function, (4b) Effect of Negative Offset for Codes Near Zero-Scale, (4c) Effect of Positive Full-Scale Error for Codes Near Full-Scale

# PACKAGE DESCRIPTION

## GN Package 16-Lead Plastic SSOP (Narrow .150 Inch) (Reference LTC DWG # 05-08-1641)



NOTE:

1. CONTROLLING DIMENSION: INCHES
2. DIMENSIONS ARE IN INCHES (MILLIMETERS)
3. DRAWING NOT TO SCALE

\*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

\*\*DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

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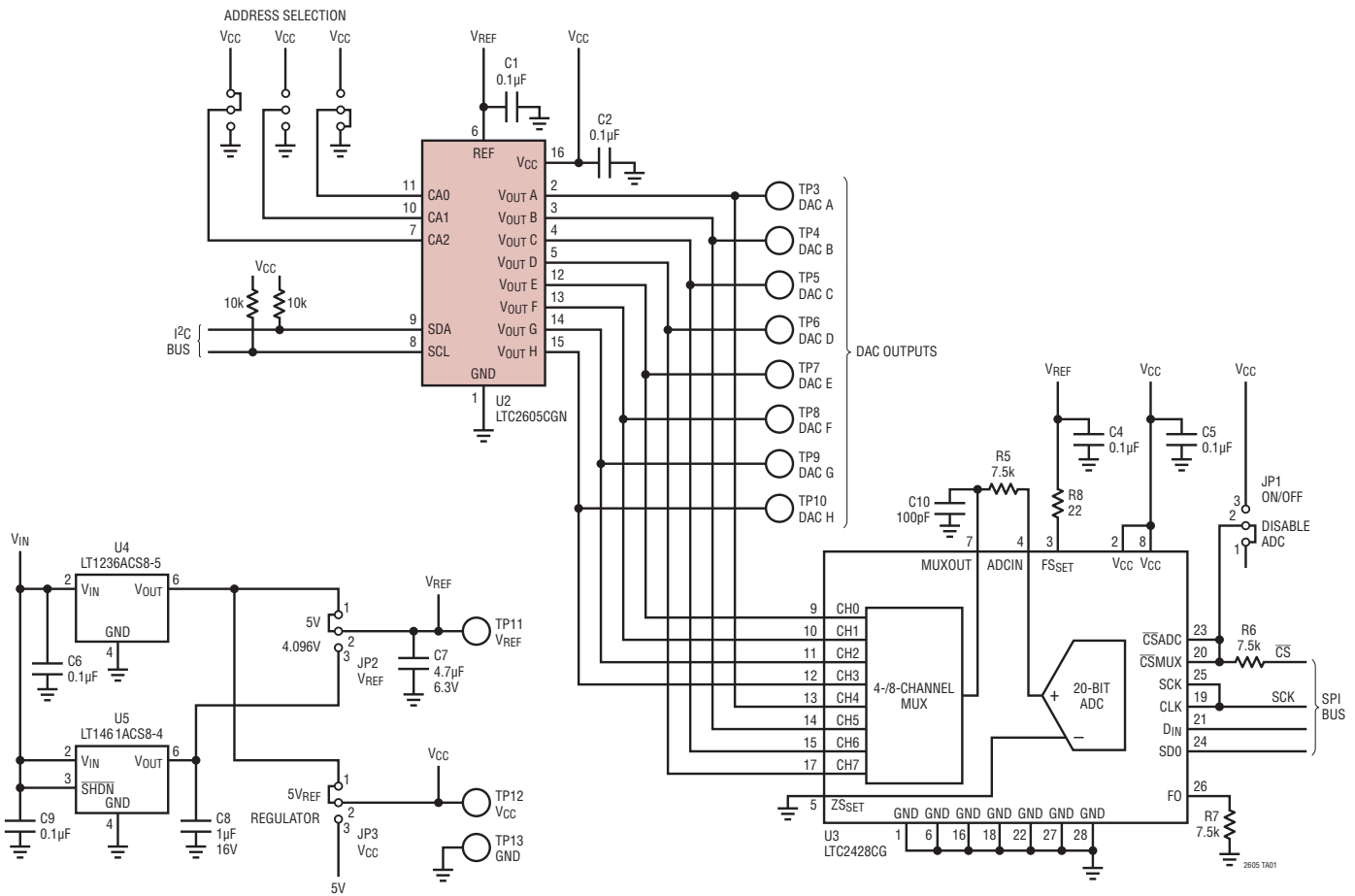
**REVISION HISTORY**

| REV | DATE  | DESCRIPTION                                    | PAGE NUMBER |
|-----|-------|------------------------------------------------|-------------|
| A   | 11/09 | Added Text to Serial Digital Interface Section | 11          |

# LTC2605/LTC2615/LTC2625

## TYPICAL APPLICATION

### Demonstration Circuit—LTC2428 20-Bit ADC Measures Key Performance Parameters



## RELATED PARTS

| PART NUMBER                 | DESCRIPTION                                                                         | COMMENTS                                                                                                                          |
|-----------------------------|-------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| LTC1458/LTC1458L            | Quad 12-Bit Rail-to-Rail Output DACs with Added Functionality                       | LTC1458: $V_{CC} = 4.5V$ to $5.5V$ , $V_{OUT} = 0V$ to $4.096V$<br>LTC1458L: $V_{CC} = 2.7V$ to $5.5V$ , $V_{OUT} = 0V$ to $2.5V$ |
| LTC1654                     | Dual 14-Bit Rail-to-Rail $V_{OUT}$ DAC                                              | Programmable Speed/Power, $3.5\mu s/750\mu A$ , $8\mu s/450\mu A$                                                                 |
| LTC1655/LTC1655L            | Single 16-Bit $V_{OUT}$ DAC with Serial Interface in SO-8                           | $V_{CC} = 5V(3V)$ , Low Power, Deglitched                                                                                         |
| LTC1657/LTC1657L            | Parallel 5V/3V 16-Bit $V_{OUT}$ DAC                                                 | Low Power, Deglitched, Rail-to-Rail $V_{OUT}$                                                                                     |
| LTC1660/LTC1665             | Octal 10-/8-Bit $V_{OUT}$ DAC in 16-Pin Narrow SSOP                                 | $V_{CC} = 2.7V$ to $5.5V$ , Micropower, Rail-to-Rail Output                                                                       |
| LTC1821                     | Parallel 16-Bit Voltage Output DAC                                                  | Precision 16-Bit Settling in $2\mu s$ for 10V Step                                                                                |
| LTC2600/LTC2610/<br>LTC2620 | Octal 16-/14-/12-Bit $V_{OUT}$ DACs in 16-Lead SSOP                                 | $250\mu A$ per DAC, $2.5V$ to $5.5V$ Supply Range, Rail-to-Rail Output, SPI Interface                                             |
| LTC2601/LTC2611/<br>LTC2621 | Single 16-/14-/12-Bit $V_{OUT}$ DACs in 10-Lead DFN                                 | $300\mu A$ per DAC, $2.5V$ to $5.5V$ Supply Range, Rail-to-Rail Output, SPI Interface                                             |
| LTC2602/LTC2612/<br>LTC2622 | Dual 16-/14-/12-Bit $V_{OUT}$ DACs in 8-Lead MSOP                                   | $300\mu A$ per DAC, $2.5V$ to $5.5V$ Supply Range, Rail-to-Rail Output, SPI Interface                                             |
| LTC2604/LTC2614/<br>LTC2624 | Quad 16-/14-/12-Bit $V_{OUT}$ DACs in 16-Lead SSOP                                  | $250\mu A$ per DAC, $2.5V$ to $5.5V$ Supply Range, Rail-to-Rail Output, SPI Interface                                             |
| LTC2606/LTC2616/<br>LTC2626 | Single 16-/14-/12-Bit $V_{OUT}$ DACs with I <sup>2</sup> C Interface in 10-Lead DFN | $270\mu A$ per DAC, $2.7V$ to $5.5V$ Supply Range, Rail-to-Rail Output, I <sup>2</sup> C Interface                                |

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